

## DECLARATION OF COMPLIANCE

Date: August 22<sup>nd</sup>, 2022

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*Smart Modular Technologies Indústria e Comércio de Equipamentos Eletrônicos*, certifies that the parts manufactured as listed below are compliant with Directive 2011/65/EU of the European Parliament and of the Council of 08 June 2011 related to the restriction of the use of certain hazardous substances in electrical and electronics equipment (RoHS Directives), including the Annex II from 31 March 2015, and International Electrotechnical Commission (IEC), about halogens free.

<b>ROHS - Maximum concentration values tolerated by weight in HM</b>	
1. Lead: 1000ppm	6. Polybrominated diphenyl ethers (PBDE): 1000ppm
2. Mercury: 1000ppm	7. Phthalates: 7.1 Bis(2-ethylhexyl) – DEHP: 1000ppm 7.2 Butyl benzyl –BBP: 1000ppm 7.3 Dibutyl phthalate – DBP: 1000ppm 7.4 Diisobutyl – DIBP: 1000ppm
3. Cadmium: 100ppm	
4. Hexavalent chromium: 1000ppm	
5. Polybrominated biphenyls PBB: 1000ppm	
<b>HALOGENS - Maximum concentration values tolerated by weight in HM</b>	
1. Chlorine: 900ppm	2. Bromine: 900ppm
Sum of Halogens: 1500ppm	

Item	SMART Part Number	Part Description
01	KTDM8G4B832BGCBCT KTDM8G4B832BGIBCT	DDR4 D1x 8Gb C-DIE x8 78B BI
02	KTDMAG4B832BGIBAT KTDMAG4B832BGCBAT	DDR4 D1x 16Gb A-DIE x8 78B BI
03	KTDM8G4B632BGCBCT KTDM8G4B632BGIBCT	DDR4 D1x 8Gb C-DIE x16 96B BI
04	KTDMAG4B632BGIBAT KTDMAG4B632BGCBAT	DDR4 D1x 16Gb A-DIE x16 96B BI

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***Approved by corporate e-mail*** /August, 22<sup>nd</sup>, 2022

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